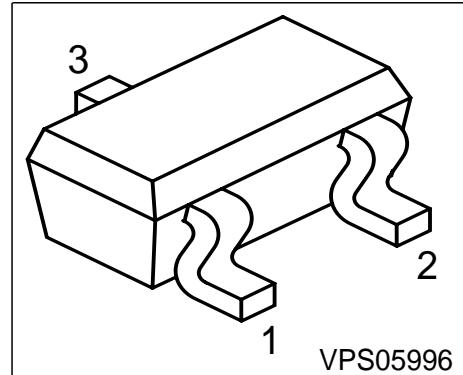


NPN Silicon RF Transistor

Preliminary data

- For low noise, high-gain broadband amplifiers at collector currents from 1 mA to 20 mA
- $f_T = 9$ GHz
- $F = 1.0$ dB at 1 GHz



ESD: Electrostatic discharge sensitive device, observe handling precaution!

Type	Marking	Pin Configuration			Package
BFR949T	RKs	1 = B	2 = E	3 = C	SC75

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CEO}	10	V
Collector-emitter voltage	V_{CES}	20	
Collector-base voltage	V_{CBO}	20	
Emitter-base voltage	V_{EBO}	1.5	
Collector current	I_C	35	mA
Base current	I_B	4	
Total power dissipation $T_S \leq 75^\circ\text{C}^1$	P_{tot}	250	mW
Junction temperature	T_J	150	$^\circ\text{C}$
Ambient temperature	T_A	-65 ... 150	
Storage temperature	T_{stg}	-65 ... 150	

Thermal Resistance

Junction - soldering point ²⁾	R_{thJS}	≤ 300	K/W
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¹ T_S is measured on the collector lead at the soldering point to the pcb

² For calculation of R_{thJA} please refer to Application Note Thermal Resistance

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage $I_C = 1 \text{ mA}, I_B = 0$	$V_{(\text{BR})\text{CEO}}$	10	-	-	V
Base-emitter forward voltage $I_E = 25 \text{ mA}$	V_{BEF}	-	-	1.05	
Collector-base cutoff current $V_{CB} = 10 \text{ V}, I_E = 0$	I_{CBO}	-	-	100	nA
Emitter-base cutoff current $V_{EB} = 1 \text{ V}, I_C = 0$	I_{EBO}	-	-	0.1	µA
DC current gain $I_C = 5 \text{ mA}, V_{CE} = 6 \text{ V}$	h_{FE}	100	140	200	-

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC characteristics (verified by random sampling)					
Transition frequency $I_C = 15 \text{ mA}, V_{CE} = 6 \text{ V}, f = 1 \text{ GHz}$	f_T	7	9	-	GHz
Collector-base capacitance $V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}$	C_{cb}	-	0.33	0.4	pF
Collector-emitter capacitance $V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}$	C_{ce}	-	0.2	-	
Emitter-base capacitance $V_{EB} = 0.5 \text{ V}, f = 1 \text{ MHz}$	C_{eb}	-	0.6	-	
Noise figure $I_C = 5 \text{ mA}, V_{CE} = 6 \text{ V}, Z_S = Z_{\text{Sopt}}, f = 1 \text{ GHz}$ $I_C = 3 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_{\text{Sopt}}, f = 1.8 \text{ GHz}$	F	-	1	2.5	dB
Power gain, maximum stable ¹⁾ $I_C = 10 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_{\text{Sopt}}, Z_L = Z_{\text{Lopt}}, f = 900 \text{ MHz}$	G_{ms}	-	20	-	
Power gain, maximum available ²⁾ $I_C = 10 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_{\text{Sopt}}, Z_L = Z_{\text{Lopt}}, f = 1.8 \text{ GHz}$	G_{ma}	-	14	-	
Transducer gain $I_C = 15 \text{ mA}, V_{CE} = 6 \text{ V}, Z_S = Z_L = 50\Omega, f = 1 \text{ GHz}$ $I_C = 10 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_L = 50\Omega, f = 1.8 \text{ GHz}$	$ S_{21e} ^2$	13 -	16 11	-	

¹ $G_{ms} = |S_{21} / S_{12}|$

² $G_{ma} = |S_{21} / S_{12}| (k - (k^2 - 1)^{1/2})$

SPICE Parameters (Gummel-Poon Model, Berkley-SPICE 2G.6 Syntax) :

Transistor Chip Data

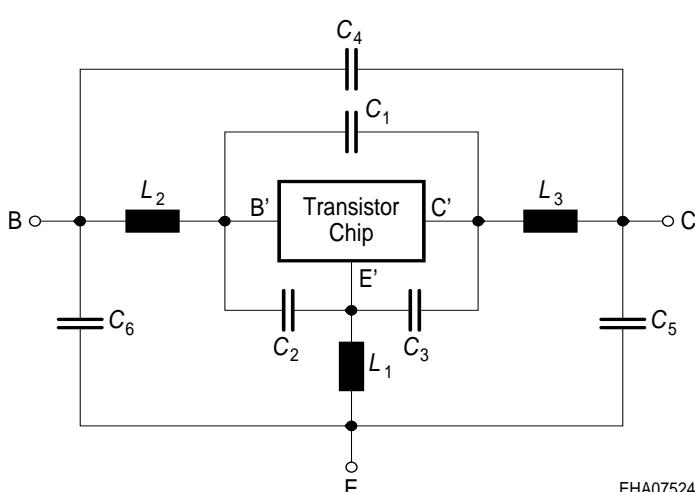
IS =	4.36	fA	BF =	120	-	NF =	1.085	-
VAF =	30	V	IKF =	0.152	A	ISE =	1.86	pA
NE =	1.998	-	BR =	33.322	-	NR =	1.095	-
VAR =	41.889	V	IKR =	0.063	A	ISC =	3.68	pA
NC =	1.569	-	RB =	20.766	Ω	IRB =	72.2	μ A
RBM =	0.823	Ω	RE =	0.101		RC =	0.849	Ω
CJE =	291	fF	VJE =	0.586	V	MJE =	0.456	-
TF =	8.77	ps	XTF =	0.00894	-	VTF =	0.198	V
ITF =	1.336	mA	PTF =	0	deg	CJC =	459	fF
VJC =	1.048	V	MJC =	0.334	-	XCJC =	0.217	-
TR =	1.39	ns	CJS =	0	fF	VJS =	0.75	V
MJS =	0	-	NK =	0.5	-	EG =	1.11	eV
.	-		FC =	0.924	-	TNOM	300	K

All parameters are ready to use, no scaling is necessary.

Extracted on behalf of Infineon Technologies AG by:

Institut für Mobil- und Satellitentechnik (IMST)

Package Equivalent Circuit:

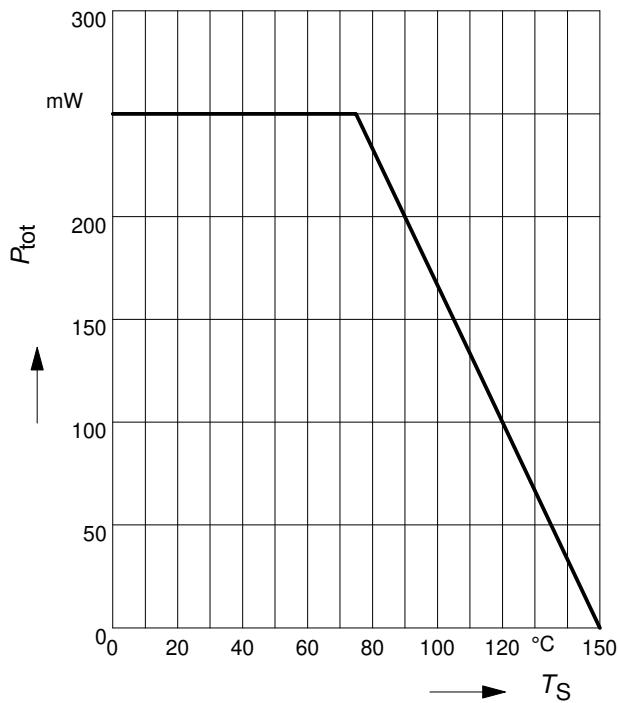


L_1 =	0.762	nH
L_2 =	0.706	nH
L_3 =	0.382	nH
C_1 =	62	fF
C_2 =	84	fF
C_3 =	180	fF
C_4 =	7	fF
C_5 =	40	fF
C_6 =	48	fF

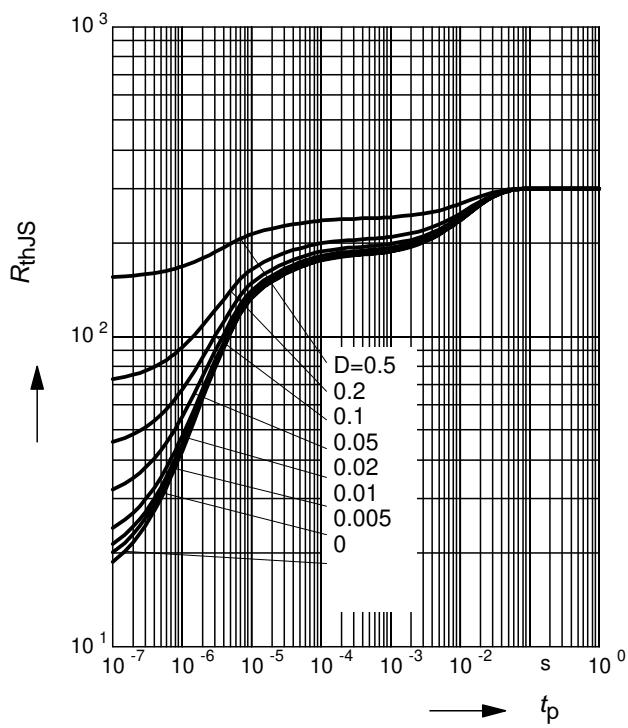
Valid up to 6GHz

For examples and ready to use parameters please contact your local Infineon Technologies distributor or sales office to obtain a Infineon Technologies CD-ROM or see Internet: <http://www.infineon.com/silicondiscretes>

Total power dissipation $P_{\text{tot}} = f(T_S)$

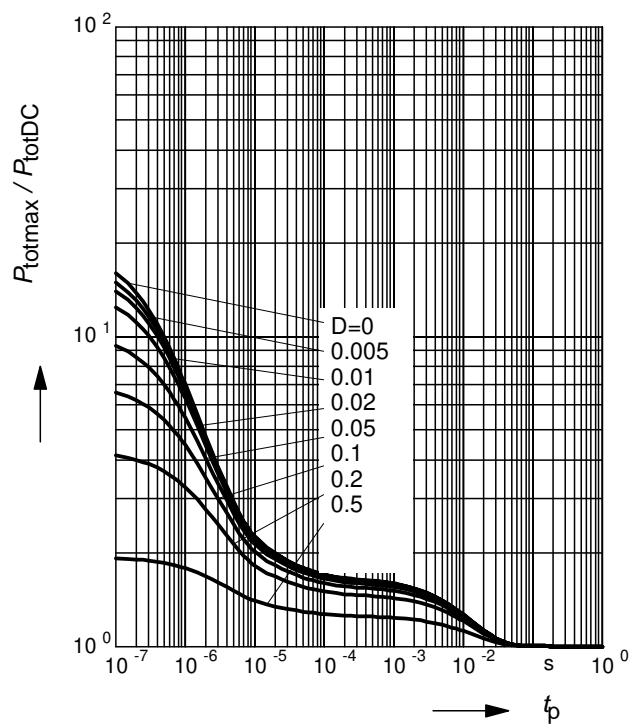


Permissible Pulse Load $R_{\text{thJS}} = f(t_p)$

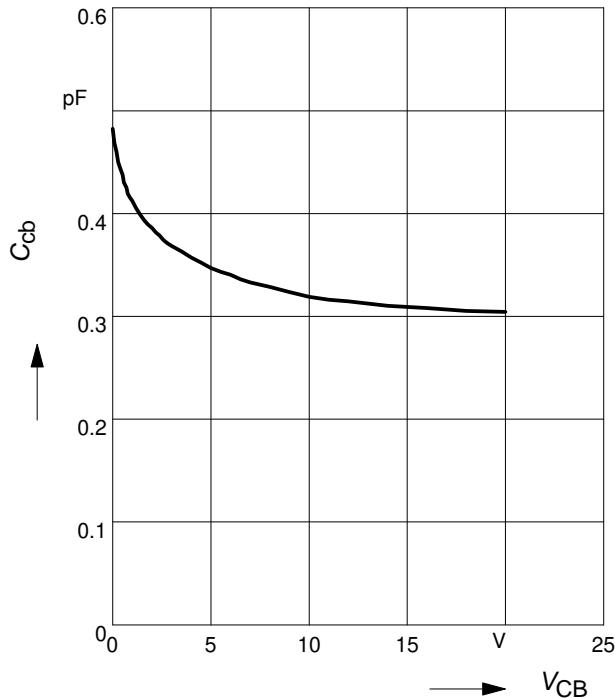


Permissible Pulse Load

$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$$

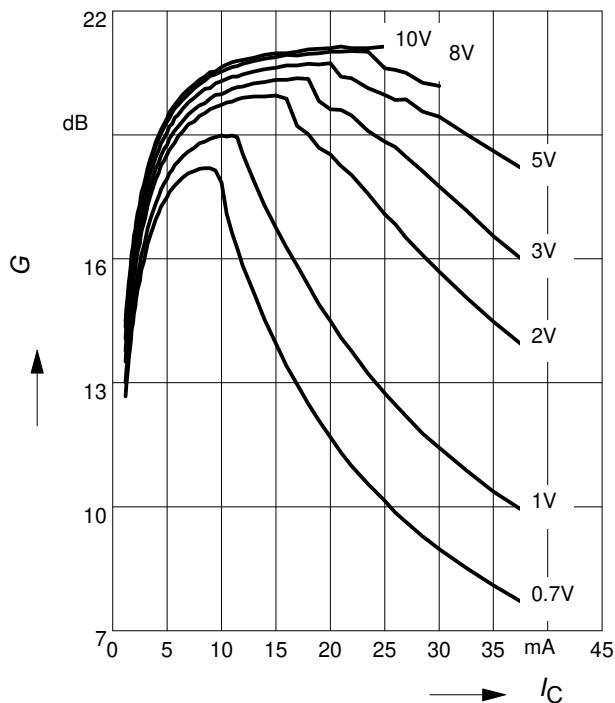


Collector-base capacitance $C_{cb} = f(V_{CB})$
 $f = 1\text{MHz}$



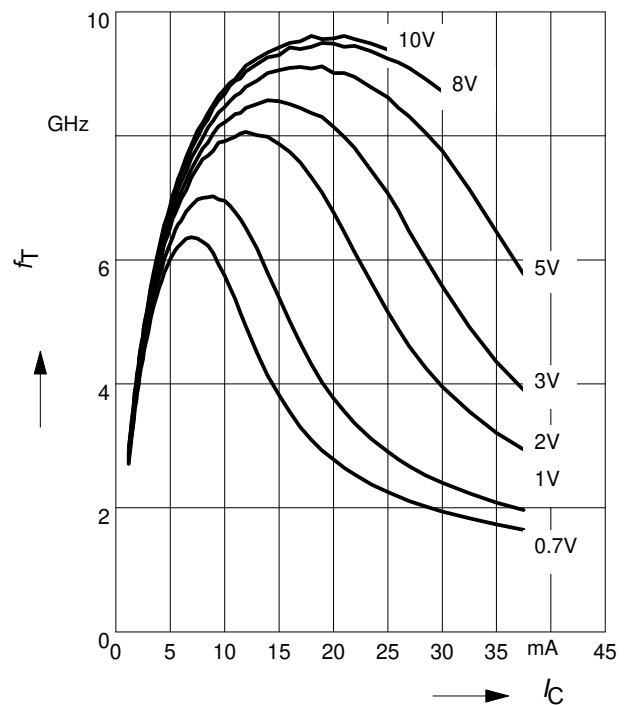
Power Gain $G_{ma}, G_{ms} = f(I_C)$
 $f = 0.9\text{GHz}$

V_{CE} = Parameter



Transition frequency $f_T = f(I_C)$

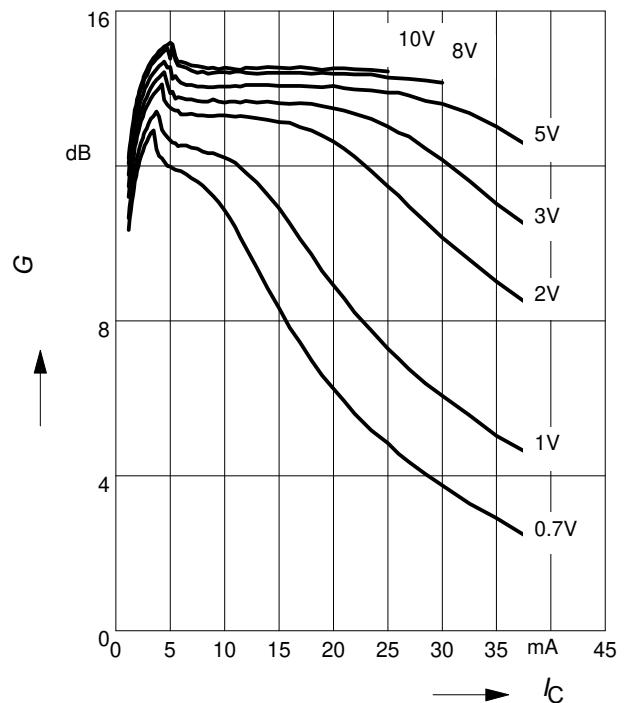
V_{CE} = Parameter



Power Gain $G_{ma}, G_{ms} = f(I_C)$
 $f = 1.8\text{GHz}$

Power Gain $G_{ma}, G_{ms} = f(I_C)$
 $f = 1.8\text{GHz}$

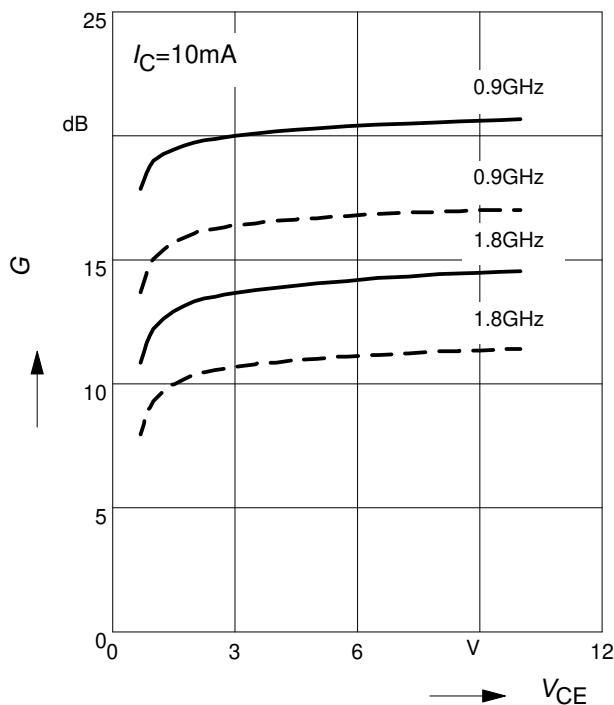
V_{CE} = Parameter



Power Gain G_{ma} , $G_{ms} = f(V_{CE})$: _____

$|S_{21}|^2 = f(V_{CE})$: -----

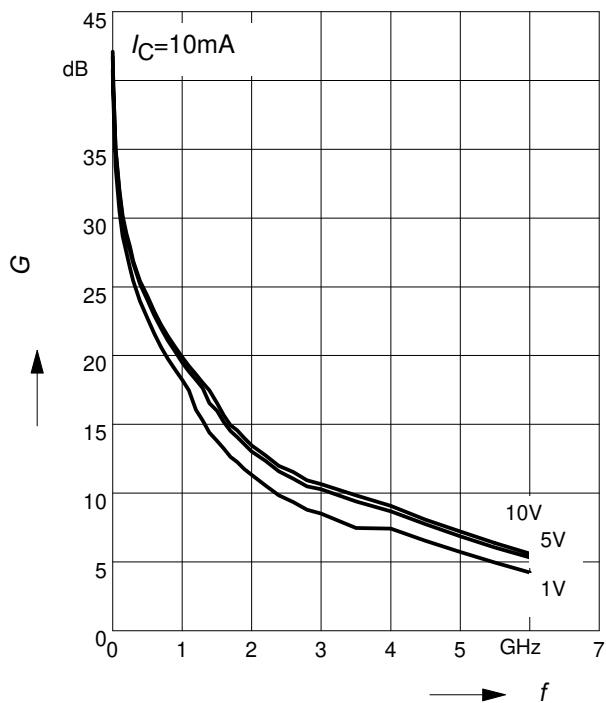
f = Parameter



Power Gain G_{ma} , $G_{ms} = f(f)$

Power Gain $|S_{21}|^2 = f(f)$

V_{CE} = Parameter



V_{CE} = Parameter

